

Features

- Low Supply Current: I_{DD} 6 μA (Typical)
- Single Pow er Supply Operation
- Wide Common-Mode Input Voltage Range
- Push-Pull Output Circuit
- Low Input Bias Current
- Internal Hysteresis
- Packaged in MicroPak[™] 6

Applications

- Mobile Phones
- Alarm and Security Systems
- Personal Digital Assistants

Description

The FAN156 is a low-power single comparator that typically consumes less than $10 \,\mu$ A of supply current. It is guaranteed to operate at a low voltage of 1.6 V and is fully operational up to 5.5 V, making it convenient for use in 1.8, 3.0 V, and 5.0 V systems.

The FAN156 has a complementary push-pull P- and Nchannel output stage capable of driving a rail-to-rail output swing with a load ranging up to 5.0 mA.



Figure 1. Functional Diagram

Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package	Packing Method	
FAN156L6X	CN	-40 to 85°C	6-Lead, MicroPak™, 1 x 1.45 mm Wide	5000 Units on Tape and Reel	

Pin Configuration OUT 1 6 VSS 2 5 N+ 3 4



Pin Definitions

Pin #	Name	Description		
1	OUT	Comparator Output		
2	V _{SS}	Negative Supply Voltage		
3	IN+	Non-Inverting Input		
4	IN-	Inverting Input		
5	NC	No Connect		
6	V _{DD}	Positive Supply Voltage		

Function Table

Inputs	Outputs
IN(-) > IN(+)	Output LOW
IN(+) > IN(-)	Output HIGH





Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Condition	Min.	Max.	Unit
Vap to Vap	Supply Voltage		-3.0	+3.0	V
V DD IO V SS	Supply vollage		0	6.0	v
DVIN	Differential Input Voltage			±6	
V _{IN}	Input Voltage			V_{SS} to V_{DD}	V
ts	Output Short Circuit Duration ⁽¹⁾			Indefinite	S
TJ	Junction Temperature			+150	°C
T _{STG}	Storage Temperature Range		-65	+150	°C
PD	Pow er Dissipation			194	mW
Θја	Thermal Resistance			335	°C/W
	IEC 61000 4 2 System ESD	Air Gap		15	
	IEC 61000-4-2 System ESD	Contact		8	
	IEDEC IESDO2 A114 Liumon Bady	All Pins		8	
ESD	JEDEC JESD22-A114, Human Body Model	Pin to Pin: IN(-), IN(+) to V _{DD} or VSS		12	kV
	JEDEC JESD22-C101, Charged Device Model	All Pins		2	

Note:

1. The maximum total power dissipation must not be exceeded.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Condition	Min.	Max.	Unit
Vpp to Voo	Pow er Supply		-2.75	+2.75	V
V DD 10 V 55			0	5.50	v
V _{DD}	Pow er Supply	V _{SS} 0 V	1.6	5.5	V
V _{IN}	Input Voltage			V_{SS} to V_{DD}	V
		V _{DD} 5.0 V		5	
I _{OH} /I _{OL}	Output Sink/Source Current	V _{DD} 3.0 V		3	mA
		V _{DD} 1.6 V		1	
TA	Operating Temperature, Free Air		-40	+85	°C

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
/ _{DD} =5.5V,Vs	_{s=} GND, and T _A =+25°C		<u> </u>			
V _{HYS}	Input Hysteresis	V _{CM} =0.5 V _{DD}		4		mV
V _{IO}	Input Offset Voltage ⁽²⁾	V _{CM} =0.5 V _{DD}	-15	±1	+15	mV
lio	Input Offset Current			10		pА
lı	Input Bias Current			10		pА
V _{CM}	Common Mode Input Voltage		V _{SS}		V _{DD}	V
CMRR	Common Mode Rejection Ratio ⁽³⁾	V _{CM} =V _{DD}		68		dB
ldd	Supply Current			6	17	μA
PSRR	Pow er Supply Rejection Ratio ⁽³⁾	$\Delta V_{DD}=0.5 V$	45	80		dB
laa	Output Short Circuit Ourront	V _O =V _{DD}		60		m۸
los	Output Short Circuit Current	Vo=VSS		90		mA
V _{OL}	Low - Level Output Voltage	I _{SINK} =5.0 mA		0.1	0.3	V
Voh	High-Level Output Voltage	Isource=5.0 mA	5.2	5.4		V
t PLH	Propagation Delay (Turn-On)	Overdrive 20 mV, $C_L=15 \text{ pF}$		0.40		μs
t PHL	Propagation Delay (Turn-Off)	Overdrive=20 mV, C _L =15 pF		0.42		μs
t⊤∟н	Response Time, Output Rise/Fall ⁽⁴⁾	C∟=50 pF		4.0		ns
t _{THL}				5.4		115
V _{DD} =3V, V _{SS} =	-GND, and T _A =+25°C				•	
V _{HYS}	Input Hysteresis	V _{CM} =0.5 V _{DD}		4		mV
V _{IO}	Input Offset Voltage ⁽²⁾	V _{CM} =0.5 V _{DD}	-15	±1	+15	mV
lio	Input Offset Current			10		pА
l	Input Bias Current			10		pА
V _{CM}	Common Mode Input Voltage		V _{SS}		V _{DD}	V
CMRR	Common Mode Rejection Ratio ⁽³⁾	V _{CM} =V _{DD}		60		dB
lod	Supply Current			5.5	15.0	μA
PSRR	Pow er Supply Rejection Ratio ⁽³⁾	$\Delta V_{DD}=0.5 V$	45	80		dB
los	Output Short Circuit Current	V _O =V _{DD}		27		mA
03		V _O =V _{SS}		35		
Vol	Low -Level Output Voltage	I _{SINK} =3.0 mA		0.15	0.35	V
V _{OH}	High-Level Output Voltage	I _{SOURCE} =3.0 mA	2.65	2.85		V
t _{PLH}	Propagation Delay (Turn-On)	Overdrive=20 mV, C_L =15 pF		0.45		μs
t PHL	Propagation Delay (Turn-Off)	Overdrive=20 mV, C_L =15 pF		0.47		μs
t⊤∟н	Response Time, Output Rise/Fall ⁽⁴⁾			6.1	1	
t _{THL}	Response nine, Output Rise/Fall	C∟=50pF		6.2	1	ns

Continued on the following page ...

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V _{DD} 1.6V, Vs	s GND, and T _A =+25°C					
V _{HYS}	Input Hysteresis	V _{CM} =0.5 V _{DD}		3.5		mV
V _{IO}	Input Offset Voltage ⁽²⁾	V _{CM} =0.5 V _{DD}	-15	±1	+15	mV
lio	Input Offset Current			10		pА
h	Input Bias Current			10		pА
Vсм	Common Mode Input Voltage		V _{SS}		V _{DD}	V
CMRR	Common Mode Rejection Ratio ⁽³⁾	V _{CM} =V _{DD}		56		dB
lod	Supply Current			5	15	μA
PSRR	Power Supply Rejection Ratio ⁽³⁾	$\Delta V_{DD}=0.5 V$	45	80	1	dB
los	Output Short Circuit Current	V _O =V _{DD}		5.5		mA
IOS		V _O =V _{SS}		7.5		
V _{OL}	Low -Level Output Voltage	I _{SINK} =1.0 mA		0.10	0.25	V
V _{OH}	High-Level Output Voltage	Isource=1.0 mA	1.35	1.50		V
t _{PLH}	Propagation Delay (Turn-On)	Overdrive=20 Mv, C _L =15pF		0.52		μs
t PHL	Propagation Delay (Turn-Off)	Overdrive=20 Mv, C _L =15 pF		0.54		μs
t _{TLH}	Response Time, Output Rise/Fall ⁽⁴⁾	0 50 55		16.5		-
t _{THL}	Response nime, Output Rise/Fall	C∟=50 pF		13.0		ns

Differential input switching level is guaranteed at the minimum or maximum offset voltage, minus or plus half the 2. maximum hysteresis voltage.
Guaranteed by design and characterization data.
Input signal: 1 kHz, square-wave signal with 10 ns edge rate.



280

260

240

220

200

-60

-40

-20

0

20

Те

Figure 9. Propagation Delay (tPHL) vs. Temperature

40

60

10.00

VDD=3.0V

VDD=5.5V

1.00

ISINK, Output Sink Current (mA)

Output LOW vs. Output Drive Current

10

1

Figure 8.

0.10

FAN156 — Low Voltage Comparator

-1.6VDD

-3.0VDD

5.5VDD

100

80

tpLH

tpHL

250



Figure 10. Propagation Delay (tPLH) vs. Temperature





Figure 12. Input Common-Mode Voltage Range vs. Supply Voltage



Figure 13. Power-Up Delay



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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
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L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

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